



# LADEE Mission

## Interface Requirements Document

([Revision: Template])

March 7, 2008

---

Document Custodian: \_\_\_\_\_ Date  
Payload Engineer

---

Approved by \_\_\_\_\_ Date  
Principal Investigator

---

Approved by [Inst Mgr - TBS], \_\_\_\_\_ Date  
Instrument Manager

---

Approved by \_\_\_\_\_ Date  
Payload Manager

---

Approved by \_\_\_\_\_ Date  
Payload Systems Engineer

---

Approved by \_\_\_\_\_ Date  
Avionics Engineer

---

Approved by \_\_\_\_\_ Date  
Software Engineer

---

Approved by \_\_\_\_\_ Date  
Mechanical Engineer



National Aeronautics and  
Space Administration \_\_\_\_\_

Goddard Space Flight Center  
Greenbelt, Maryland \_\_\_\_\_

THIS PAGE INTENTIONALLY BLANK

**LADEE Mission**  
**<instrument name> INTERFACE REQUIREMENTS DOCUMENT**

**INTERFACE REQUIREMENTS CHANGE LOG**

Date	Revision	Changes
[TBS]	<b>Initial Draft</b>	Initial draft

THIS PAGE INTENTIONALLY BLANK

## Table of Contents

1.	PURPOSE.....	7
2.	<instrument name> DESCRIPTION.....	7
2.1	Operational Overview.....	7
3.	APPLICABLE AND REFERENCE DOCUMENTS .....	8
4.	CABLES, HARNESSES AND CONNECTORS .....	9
4.1	ELECTRICAL HARNESS.....	9
4.1.1	Harness Designations.....	9
4.2	ELECTRICAL CONNECTORS.....	9
4.2.1	Connector Location.....	9
4.2.2	Connector Keying Requirements.....	9
4.2.3	Electrical Connector Designations .....	9
5.	ELECTRICAL POWER INTERFACES.....	9
5.1	Unregulated Power Switches .....	9
5.2	Unregulated Power Requirements .....	9
5.3	Power Switch Current Requirements.....	9
5.4	Fault Protection .....	9
5.5	Failure Propagation.....	9
5.6	Power Requirements.....	9
5.7	Electromagnetic Interference/Compatibility (EMI/EMC) .....	9
5.4	GROUND AND ELECTRICAL ISOLATION .....	9
5.4.8	Analog Current Input Interfaces .....	9
6.	COMMAND AND DATA HANDLING (C&DH) INTERFACES .....	10
6.1	DATA TRANSMIT FROM INSTRUMENT TO LADEE INTERFACE .....	10
6.1.1	Low Power/Low Speed U-ART Specifications .....	10
6.1.2	1553 Specifications.....	10
6.1.3	High Speed LVDS Specifications .....	10
6.1.4	High Speed RS-422 Specifications.....	10
6.1.5	Time Tic Interface .....	10
6.1.6	Discrete Output Interfaces.....	10
6.1.7	Discrete Input Interfaces .....	10
6.1.8	Analog Sensor Interfaces .....	11
6.2	DATA COMPRESSION .....	11
6.2.1	Data Compression Ground Rules .....	11
6.2.2	<instrument name> Data Stream into the Spacecraft NVRAM Pre-compression .....	11
6.2.3	NVRAM Data Stream Post-Compression.....	11
7.	SOFTWARE INTERFACES.....	12
7.1	<instrument name> COMMAND DICTIONARY.....	12
7.2	<instrument name> TELEMETRY DICTIONARY .....	12
7.3	DATA PRODUCTS .....	12
7.4	ALGORITHMS REQUIRED TO RUN ON SPACECRAFT FLIGHT COMPUTER.....	12
7.5	COMPUTER AND MEMORY RESOURCES .....	12
7.5.1	DRAM Allocation.....	12
7.5.2	Sequence Engines .....	12
7.5.3	Non-Volatile RAM (NVRAM).....	12

7.6	TIMING .....	12
7.6.1	Execution of Events .....	12
7.6.2	Frequency & Jitter.....	12
7.6.3	Time Tagging.....	12
7.6.4	Power-Up Timing .....	12
7.6.5	Reset Timing.....	12
7.6.6	Safing Timing .....	13
7.7	FAULT PROTECTION.....	13
7.7.1	<instrument name> Aliveness Checking.....	13
7.7.2	Fault Protection Control.....	13
7.7.3	<instrument name> Power Switch Fault Protection .....	13
7.11	SOFTWARE INTERFACE IMPLEMENTATIONS.....	13
7.11.1	Software Interfaces Implemented Over UART .....	13
7.11.2	Software Interfaces Implemented Over 1553B .....	13
7.11.3	Software Interfaces Implemented Over high speed point-to-point (LVDSor RS-422) .....	13
7.11.4	Software Interfaces Implemented Through Discrete Lines.....	14
7.12	SERVICES .....	14
8.	MECHANICAL INTERFACES .....	15
8.2	INSTRUMENT MASS RESPONSIBILITIES .....	15
8.3	PHYSICAL CHARACTERISTICS .....	15
8.3.1	Envelope and Dimensions .....	15
8.3.2	Mass Properties.....	15
8.4	MOUNTING INTERFACE DEFINITION .....	15
8.4.1	Instrument Component Locations.....	15
8.4.2	Mounting Surfaces .....	15
8.4.3	Mounting Hardware .....	15
8.4.4	Mounting Hole Locations.....	15
8.4.5	Instrument Component Locations.....	15
8.4.6	Fields of View.....	15
8.4.7	Sun Avoidance.....	15
8.4.8	Alignment Reference .....	15
8.4.9	Flight Calibration Target(s), Fiducials, Alignment Cubes, etc.....	15
8.4.10	Grounding and Ground Straps .....	15
8.5	Intra-instrument Cables Between Non-collocated Elements .....	15
8.6	VENTING .....	15
8.7	PURGE / VACUUM MECHANICAL INTERFACES.....	15
8.9	MICROPHONICS .....	15
8.10	MECHANISMS .....	16
8.11	RESERVED - OTHER INSTRUMENT SPECIFIC INTERFACES.....	16
8.12	RESERVED - OTHER INSTRUMENT SPECIFIC INTERFACES.....	16
9.	THERMAL INTERFACE .....	16
9.1	THERMAL INTERFACE DATA.....	16
9.1.1	Thermal Models.....	16
9.1.2	Thermal Analyses .....	16

9.1.3	Thermal Isolation .....	16
9.1.4	<instrument name> Instrument (external).....	16
9.2	THERMAL MAINTENANCE / CONTROL .....	16
9.2.1	Thermal Control Hardware.....	16
9.3	INSTRUMENT FLIGHT ALLOWABLE TEMPERATURES.....	16
9.3.1	Instrument Alarm Limits.....	16
10.	ENVIRONMENTAL INTERFACES .....	16
10.1	SYSTEM ENVIRONMENTS.....	16
10.2	CONTAMINATION CONTROL .....	16
10.2.1	Particulate Contamination Control .....	16
10.2.2	Organic Contamination Control .....	16
10.2.2	Surface Cleanliness .....	16
10.2.3	Non-metallic Materials.....	16
10.3	PLANETARY PROTECTION .....	16
10.3.1	Pre-Delivery Bioburden Control.....	16
10.3.2	Bioassay Requirements .....	16
10.3.3	Exposed Surface Area.....	16
11.	OPERATIONAL CONSTRAINTS AND FLIGHT RULES .....	16
11.1	TIME OF DAY CONSTRAINTS ON OPERATIONS.....	17
11.2	OPERATIONAL TIMELINE CONSTRAINTS.....	17
12.	INTEGRATION AND TEST .....	17
12.1	INTEGRATION .....	17
12.1.1	Alignment.....	17
12.2	SYSTEM-LEVEL ENVIRONMENTAL TESTING .....	17
12.2.1	System-level Vibration.....	17
12.2.2	System-level Pyro-shock.....	17
12.2.3	System-level Thermal Balance Test .....	17
12.2.4	System-level EMI/EMC Test .....	17
12.3	BENCH ACCEPTANCE TEST .....	17
12.3.1	Calibration/Verification .....	17
12.4	INTEGRATION AND TEST EQUIPMENT / GROUND SUPPORT EQUIPMENT .....	17
12.4.1	Bench Checkout Equipment (BCE) .....	17
12.4.2	Protective Covers .....	17
12.4.3	GSE Cables.....	17
12.4.4	Mass Simulator .....	17
12.4.5	Electronics Simulator .....	17
13.	GROUND OPERATIONS - HANDLING AND ENVIRONMENTAL REQUIREMENTS .....	17
13.1	HANDLING PROCEDURES .....	17
13.1.1	Instrument Flight Hardware .....	17
13.1.2	Ground Support Equipment.....	17
13.2	HANDLING FIXTURES .....	17
13.3	STORAGE REQUIREMENTS .....	17
13.3.1	Instrument Flight Hardware .....	17
13.3.2	Ground Support Equipment.....	17
13.4	PURGE REQUIREMENTS .....	17

13.4	REMOVE BEFORE FLIGHT ("RED TAG") ITEMS .....	17
13.5	INSTALL BEFORE FLIGHT ("GREEN TAG") ITEMS .....	17
13.6	SHIPPING AND HANDLING .....	17
14.	RESERVED .....	18
15.	DOCUMENTATION AND DELIVERABLES .....	18
15.1	OPERATIONS MANUALS AND PROCEDURES .....	18
15.2	END ITEM DATA PACKAGE .....	18

Appendix A - Acronyms & Abbreviations

Appendix B - <instrument name> Flight Software Algorithms

## **1. PURPOSE**

This Interface Requirements Document (IRD) defines the <instrument name> interface requirements to the LADEE spacecraft. The requirements agreed to by the signatories of this document will form the basis of the <instrument name> Interface Control Document.

### **NOTES:**

- "Output" and "Input" are used through this document as meaning from the point of view of the instrument, except in the specific instances where a different reference frame is explicitly defined.
- The Instrument Requirements Document's format and paragraph numbers are common for all the LADEE Science instruments. As a result, for any individual instrument there will be sections that are not applicable, and all subparagraphs below a paragraph marked "N/A" may be deleted. Additional depth in the outline may be added as needed.

## **2. <instrument name> DESCRIPTION**

This section provides a general overview of the instrument. Specific requirements follow in later sections.

### **2.1 Operational Overview**

Describe how the instrument will be used in all post-launch phases, including cruise phase checkouts, EDL, and Mars Surface Operations.

### **3. APPLICABLE AND REFERENCE DOCUMENTS**

The Applicable documents listed in Table 3.1 below form an integral part of the requirements specified herein.

Table 3.1 Applicable Documents

Applicable Document	Doc ID Number	IRD Ref	Web Location
Example Documents:			
Digital Time Division Command/Response Multiplex Date Bus	MIL-STD-1553B	5.1.2	<a href="http://centauri.larc.nasa.gov/msl/pip/MIL-STD-1553B-Base.pdf">http://centauri.larc.nasa.gov/msl/pip/MIL-STD-1553B-Base.pdf</a>
Biological Contamination Control for Outbound and Inbound Planetary Spacecraft (Revalidated 10/23/03)	NPD 8020.7F	10.3	<a href="http://nодis3.gsfc.nasa.gov/library/displayDir.cfm?Internal_ID=N PD 8020 007F &amp;page_name=main">http://nодis3.gsfc.nasa.gov/library/displayDir.cfm?Internal_ID=N PD 8020 007F &amp;page_name=main</a>
Planetary Protection Provisions for Robotic Extraterrestrial Missions; April 16, 1999	NPR 8020.12B	10.3	<a href="http://nодis3.gsfc.nasa.gov/library/displayDir.cfm?Internal_ID=N PR 8020 012B &amp;page_name=main">http://nодis3.gsfc.nasa.gov/library/displayDir.cfm?Internal_ID=N PR 8020 012B &amp;page_name=main</a>

The following list summarizes documents, or specific portions there of, that are referenced within this document. Relevance is specified within the body of this document.

Table 3.2 Reference Documents

Reference Document	Doc ID Number	IRD Ref	Web Location
		X.X.X	

## **4. CABLES, HARNESES AND CONNECTORS**

describe the interfaces

### **4.1 ELECTRICAL HARNESS**

(Note: Ground support equipment cables are covered in Paragraph 12.4)

#### **4.1.1 Harness Designations**

#### **4.2 ELECTRICAL CONNECTORS**

##### **4.2.1 Connector Location**

##### **4.2.2 Connector Keying Requirements**

##### **4.2.3 Electrical Connector Designations**

#### **4.3 FIBER OPTIC CABLES**

#### **4.4 DIRECT ACCESS CONNECTOR TEST POINTS**

#### **4.5 MARKING**

## **5. ELECTRICAL POWER INTERFACES**

#### **5.1 Unregulated Power Switches**

#### **5.2 Unregulated Power Requirements**

#### **5.3 Power Switch Current Requirements**

#### **5.4 Fault Protection**

#### **5.5 Failure Propagation**

#### **5.6 Power Requirements**

Include allocation by Mission Phase, & Instrument operational modes (e.g., Nominal data collect/Standby/Survival/etc.) Instrument Power Profile,

#### **5.7 Electromagnetic Interference/Compatibility (EMI/EMC)**

#### **5.4 GROUND AND ELECTRICAL ISOLATION**

##### **5.4.8 Analog Current Input Interfaces**

NOTE: Output/Input are used here as meaning from the point of view of the instrument

## **6. COMMAND AND DATA HANDLING (C&DH) INTERFACES**

### **6.1 DATA TRANSMIT FROM INSTRUMENT TO LADEE INTERFACE**

#### **6.1.1 Low Power/Low Speed U-ART Specifications**

##### **6.1.1.1 Rate(s) of Data Generation**

##### **6.1.1.2 Telemetry Interface**

##### **6.1.1.3 Science Data Interface Signal Details**

#### **6.1.2 1553 Specifications**

##### **6.1.2.1 Implementation**

##### **6.1.2.2 Cross-Strapping**

##### **6.1.2.3 Remote Terminal Address Specification**

#### **6.1.3 High Speed LVDS Specifications**

##### **6.1.3.1 Rate(s) of Data Generation**

##### **6.1.3.2 Telemetry / Command Interface**

##### **6.1.3.3 Science Data Interface Signal Details**

#### **6.1.4 High Speed RS-422 Specifications**

##### **6.1.4.1 Rate(s) of Data Generation**

##### **6.1.4.2 Telemetry / Command Interface**

##### **6.1.4.3 Science Data Interface Signal Details**

#### **6.1.5 Time Tic Interface**

This section describes any required interface between the spacecraft timeclock and the instrument.

#### **6.1.6 Discrete Output Interfaces**

NOTE: Output/Input are used here as meaning from the point of view of the instrument

##### **6.1.6.1 Discrete Output Allocation**

##### **6.1.6.2 Discrete Output Commands**

##### **6.1.6.3 Discrete Output Electrical Interface Characteristics**

##### **6.1.6.4 Discrete Output Isolation Requirements**

##### **6.1.6.5 Discrete Output Electrical Interface**

##### **6.1.6.6 Discrete Output Signal Polarity**

#### **6.1.7 Discrete Input Interfaces**

NOTE: Output/Input are used here as meaning from the point of view of the instrument

##### **6.1.7.1 Discrete Output Allocation**

##### **6.1.7.2 Discrete Output Commands**

6.1.7.3 Discrete Output Electrical Interface Characteristics

6.1.7.4 Discrete Output Isolation Requirements

6.1.7.5 Discrete Output Electrical Interface

6.1.7.6 Discrete Output Signal Polarity

#### 6.1.8 Analog Sensor Interfaces

This section discusses analog sensor interfaces, e.g. temp sensors, current sensors, voltage sensors, etc., that require an interface directly with the spacecraft avionics.

6.1.7.1 Analog Sensor Allocation

6.1.7.2 Analog Sensor Functionality

6.1.7.3 Analog Sensor Electrical Interface Characteristics

6.1.7.4 Analog Sensor Isolation Requirements

6.1.7.5 Analog Sensor Electrical Interface

6.1.7.6 Analog Sensor Temperature Characteristics

6.1.7.7 Analog Sensor Scale Factors

6.1.7.8 Analog Sensor Processing Accuracy

6.1.7.9 Analog Sensor Installation

### 6.2 DATA COMPRESSION

This section describes data compression on <instrument name> instrument data to be performed by the Spacecraft Flight Computer.

#### 6.2.1 Data Compression Ground Rules

This section describes any ground rules for application of data compression to <instrument name> instrument data.

#### 6.2.2 <instrument name> Data Stream into the Spacecraft NVRAM Pre-compression

#### 6.2.3 NVRAM Data Stream Post-Compression

## **7. SOFTWARE INTERFACES**

### **7.1 <instrument name> COMMAND DICTIONARY**

This section defines the low-level commands (i.e., bit level protocol over spacecraft electrical interface to the instrument) required to communicate directly with the instrument, and also describes any high-level commands to be implemented in spacecraft flight software that are required to facilitate instrument operations.

### **7.2 <instrument name> TELEMETRY DICTIONARY**

This section provides the definition of the <instrument name> telemetry format, and describes the telemetry content within the context of the specified format.

### **7.3 DATA PRODUCTS**

### **7.4 ALGORITHMS REQUIRED TO RUN ON SPACECRAFT FLIGHT COMPUTER**

This section defines any instrument-unique algorithms that are required to run on the spacecraft flight computer.

### **7.5 COMPUTER AND MEMORY RESOURCES**

This section defines the spacecraft resources, including software, Dynamic RAM (DRAM), Non-Volatile RAM (NVRAM), and spacecraft flight computer CPU that are required by the <instrument name>

#### **7.5.1 DRAM Allocation**

#### **7.5.2 Sequence Engines**

#### **7.5.3 Non-Volatile RAM (NVRAM)**

NVRAM is used by LADEE for storage of Science data on the Rover. Total NVRAM reserved for science investigations is expected to be on the order of 0.7 GBytes.

##### **7.1.3.1 NVRAM Allocation**

The estimated NVRAM required to support the investigation, referencing Sol Types defined in the Proposal Information Package will be defined and discussed in this section

#### **7.5.4 SFC CPU**

##### **7.1.4.1 SFC CPU Allocation for <instrument name>**

#### **7.6 TIMING**

##### **7.6.1 Execution of Events**

###### **7.2.1.1 Spacecraft Time Update / Hardware Time Tick Timing**

###### **7.2.1.2 <instrument name> Back-to-Back Command Timing**

##### **7.6.2 Frequency & Jitter**

###### **7.2.2.1 Commands**

###### **7.2.2.1.1 NORMAL Command Frequency & Jitter**

###### **7.2.2.1.2 IMMEDIATE Command Frequency & Jitter**

###### **7.2.2.1.3 TIME UPDATE Frequency & Jitter**

##### **7.6.3 Time Tagging**

##### **7.6.4 Power-Up Timing**

##### **7.6.5 Reset Timing**

###### **7.2.5.1 Spacecraft Flight Software Reset Timing**

7.6.6 Safing Timing  
7.7 FAULT PROTECTION  
7.7.1 <instrument name> Aliveness Checking  
    7.3.1.1 Perform <instrument name> Aliveness Checking

7.7.2 Fault Protection Control  
    7.3.2.1 Fault Protection Detection Control  
    7.3.2.2 Fault Protection Response Control

7.7.3 <instrument name> Power Switch Fault Protection  
    7.3.3.1 Switch Closure  
    7.3.3.2 Voltage Level

## 7.11 SOFTWARE INTERFACE IMPLEMENTATIONS

### 7.11.1 Software Interfaces Implemented Over UART

    7.11.1.1 LVDS Message Bit Ordering  
    7.11.1.2 LVDS Message Byte Ordering  
    7.11.1.3 LVDS Frame Sizing to the SSR-NVRAM  
    7.11.1.4 Science Data  
        7.11.1.4.1 Packet Header Format  
        7.11.1.4.2 <instrument name> Instrument Data  
        7.11.1.4.3 <instrument name> Image Packets  
        7.11.1.4.4 <instrument name> Science Data Initiation  
        7.11.1.4.5 <instrument name> Science Data Image Write to NVRAM Completion  
        7.11.1.4.6 <instrument name> Science Image Processing

### 7.11.2 Software Interfaces Implemented Over 1553B

    7.11.2.1 All <instrument name> MIL-STD 1553B Interfaces  
        7.11.2.1.1 MIL-STD 1553B Message Bit Ordering  
        7.11.2.1.2 MIL-STD 1553B Message Byte Ordering  
        7.11.2.1.3 <instrument name> MIL-STD 1553B RT Addresses  
    7.11.2.2 <instrument name> Command Interface  
        7.11.2.2.1 <instrument name> MIL-STD 1553B Command Subaddresses  
        7.11.2.2.2 <instrument name> Command Messages  
    7.11.2.3 <instrument name> Engineering/Telemetry Interface  
        7.11.2.3.1 <instrument name> Engineering/Telemetry Subaddresses  
        7.11.2.3.2 <instrument name> Engineering/Telemetry Messages

### 7.11.3 Software Interfaces Implemented Over high speed point-to-point (LVDSor RS-422)

    7.11.3.1 LVDS Message Bit Ordering

- 7.11.3.2 LVDS Message Byte Ordering
- 7.11.3.3 LVDS Frame Sizing to the SSR-NVRAM
- 7.11.3.4 Science Data
  - 7.11.3.4.1 Packet Header Format
  - 7.11.3.4.2 <instrument name> Instrument Data
  - 7.11.3.4.3 <instrument name> Image Packets
  - 7.11.3.4.4 <instrument name> Science Data Initiation
  - 7.11.3.4.5 <instrument name> Science Data Image Write to NVRAM Completion
  - 7.11.3.4.6 <instrument name> Science Image Processing

#### 7.11.4 Software Interfaces Implemented Through Discrete Lines

- 6.11.4.1 Discrete Output Signals to the <instrument name> from the C&DH
- 6.11.4.1.1 Software Control of the RESET Discrete
- 6.11.4.1.2 Software Control of the Image Select Discrete
- 6.11.4.2 Discrete Input Signals from the <instrument name> to the C&DH

### 7.12 SERVICES

All instrument-related software which executes on the SFC shall use existing spacecraft software services where available. These services are used across the breadth of flight software executing on the SFC and assure uniform usage to and access of spacecraft resources. Examples of these services are:

- Ground command processing
- Pushing of telemetry
- Uplink of files
- File system
- Electrical power system interface
- Fault protection
- Time
- NVRAM interface

## **8. MECHANICAL INTERFACES**

This section includes discussion of Coordinate System, Instrument mass properties, Envelope and dimensions,

- 8.1 COORDINATE SYSTEM
- 8.2 INSTRUMENT MASS RESPONSIBILITIES
- 8.3 PHYSICAL CHARACTERISTICS

### **8.3.1 Envelope and Dimensions**

This section defines the not-to-exceed envelope required for the instrument including within the envelope any instrument-required keep-out zones, as well as the CBE physical dimensions of the hardware.

### **8.3.2 Mass Properties**

This section includes:

- Instrument Mass
- Instrument Centers Of Mass

Instrument Moments Of Inertia

### **8.4 MOUNTING INTERFACE DEFINITION**

- 8.4.1 Instrument Component Locations
- 8.4.2 Mounting Surfaces
- 8.4.3 Mounting Hardware
- 8.4.4 Mounting Hole Locations
- 8.4.5 Instrument Component Locations
- 8.4.6 Fields of View
- 8.4.7 Sun Avoidance
- 8.4.8 Alignment Reference
- 8.4.9 Flight Calibration Target(s), Fiducials, Alignment Cubes, etc.
- 8.4.10 Grounding and Ground Straps
  - 8.4.11.0 Grounding and Ground Strap Attachment
  - 8.4.11.0 Blanket Grounds
  - 8.4.11.0 Ground Surface Cleaning

### **8.5 Intra-instrument Cables Between Non-collocated Elements**

This section provides descriptions and requirements on Intra-instrument cables between non-collocated instrument elements. The Intra-instrument Cables between non-collocated instrument elements will be designed and fabricated by the LADEE flight system to meet the instrument provider's requirements.

### **8.6 VENTING**

### **8.7 PURGE / VACUUM MECHANICAL INTERFACES**

### **8.8 RADIATOR MECHANICAL INTERFACE**

### **8.9 MICROPHONICS**

This section discusses both induced microphonics and sensitivity to microphonics.

## 8.10 MECHANISMS

This section discusses mechanisms that operate at the instrument's interface, for example, a deployable dust cover. Mechanisms that are fully internal to the instrument are described here to the extent required to define any influence that extends to the spacecraft side of the instrument's interface.

## 8.11 RESERVED - OTHER INSTRUMENT SPECIFIC INTERFACES

Section 8.11 and 8.12 are reserved to address instrument specific interfaces not covered elsewhere in this document, e.g., contact force, stray light, etc.)

## 8.12 RESERVED - OTHER INSTRUMENT SPECIFIC INTERFACES.

Section 8.11 and 8.12 are reserved to address instrument specific interfaces not covered elsewhere in this document, e.g., contact force, stray light, etc.)

## 9. THERMAL INTERFACE

### 9.1 THERMAL INTERFACE DATA

#### 9.1.1 Thermal Models

#### 9.1.2 Thermal Analyses

#### 9.1.3 Thermal Isolation

#### 9.1.4 <instrument name> Instrument (external)

### 9.2 THERMAL MAINTENANCE / CONTROL

#### 9.2.1 Thermal Control Hardware

##### 8.2.1.1 Active Thermal Control Elements

##### 8.2.1.1.1 Heaters and Temperature Sensors

##### 8.2.1.1.2 Thermal Control Hardware Installation

### 9.3 INSTRUMENT FLIGHT ALLOWABLE TEMPERATURES

#### 9.3.1 Instrument Alarm Limits

## 10. ENVIRONMENTAL INTERFACES

### 10.1 SYSTEM ENVIRONMENTS

### 10.2 CONTAMINATION CONTROL

#### 10.2.1 Particulate Contamination Control

#### 10.2.2 Organic Contamination Control

#### 10.2.2 Surface Cleanliness

#### 10.2.3 Non-metallic Materials

### 10.3 PLANETARY PROTECTION

#### 10.3.1 Pre-Delivery Bioburden Control

#### 10.3.2 Bioassay Requirements

#### 10.3.3 Exposed Surface Area

## 11. OPERATIONAL CONSTRAINTS AND FLIGHT RULES

- 11.1 TIME OF DAY CONSTRAINTS ON OPERATIONS
  - e.g., nominal ops must be during daylight
- 11.2 OPERATIONAL TIMELINE CONSTRAINTS

## **12. INTEGRATION AND TEST**

### **12.1 INTEGRATION**

#### **12.1.1 Alignment**

### **12.2 SYSTEM-LEVEL ENVIRONMENTAL TESTING**

#### **12.2.1 System-level Vibration**

#### **12.2.2 System-level Pyro-shock**

#### **12.2.3 System-level Thermal Balance Test**

#### **12.2.4 System-level EMI/EMC Test**

### **12.3 BENCH ACCEPTANCE TEST**

#### **12.3.1 Calibration/Verification**

### **12.4 INTEGRATION AND TEST EQUIPMENT / GROUND SUPPORT EQUIPMENT**

#### **12.4.1 Bench Checkout Equipment (BCE)**

##### **12.5.1.1 BCE Accommodations**

##### **12.5.1.2 BCE Contamination Control**

#### **12.4.2 Protective Covers**

#### **12.4.3 GSE Cables**

#### **12.4.4 Mass Simulator**

#### **12.4.5 Electronics Simulator**

## **13. GROUND OPERATIONS - HANDLING AND ENVIRONMENTAL REQUIREMENTS**

### **13.1 HANDLING PROCEDURES**

#### **13.1.1 Instrument Flight Hardware**

#### **13.1.2 Ground Support Equipment**

### **13.2 HANDLING FIXTURES**

### **13.3 STORAGE REQUIREMENTS**

#### **13.3.1 Instrument Flight Hardware**

#### **13.3.2 Ground Support Equipment**

### **13.4 PURGE REQUIREMENTS**

Note: Mechanical characteristics of the Purge System are in Paragraph 8.6.

### **13.4 REMOVE BEFORE FLIGHT ("RED TAG") ITEMS**

### **13.5 INSTALL BEFORE FLIGHT ("GREEN TAG") ITEMS**

### **13.6 SHIPPING AND HANDLING**

**14. RESERVED**

**15. DOCUMENTATION AND DELIVERABLES**

15.1 OPERATIONS MANUALS AND PROCEDURES

15.2 END ITEM DATA PACKAGE

## Appendix A - Acronyms & Abbreviations

BCE	Bench Checkout Equipment
CBE	Current Best Estimate
C&DH	Command and Data Handling
EDL	Entry, Descent and Landing
EMI	Electromagnetic Interference
EMC	Electromagnetic Compatibility
GSE	Ground Support Equipment
ICD	Interface Control Document
JPL	Jet Propulsion Laboratory
IRD	Instrument Requirements Document
SFC	Spacecraft Flight Computer

Appendix B - <instrument name> Flight Software Algorithms .